

5SC3528V24I0CP01

- **♦**Outline(L*W*H) : 3.5*2.8*1.9mm
- ♦ High flux efficiency & Energy conservation
- **◆**Good thermal dissipation & Optical uniformity

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Features

- Forward current: \(\leq 70mA \)
- Typical view angle 50% Iv: 120°
- RoHS2.0 and REACH-compliant
- Lens color: water transparent
- MSL 2a qualified according to JEDEC J-STD20D
- ESD Level 2kV(HBM)
- Reliability Test: AEC Q-101 qualified

Applications

- Indoor signage display applications
- Indoor decorating and entertainment design
- Automotive electronics
- Special applications



■ Product Code Method

5 - S - C -3528 - V24I - 0 - C - P - 01

1) 2) 3) 4) 5) 6) 7) 8) 9

1	2	3		(5)
Process Type	Category	LED Type	Lead Frame	Dice Wavelength &Luminous Rank
5: special product	S: SMD LED	C: PLCC top view	3528:	Vxxx: red
5. special product	S. SIMP EED	D: PLCC side view	3.5*2.8mm	Julii Tod

6	7	8	9
Lap Polarity	Lens Color	Bracket or COB Specifications	Assembly Code
0: non-common anode and non-common cathode	C: water transparent	P: article mode	01: no expression above meaning for company

■ Maximum Rating(Ta=25°C)

Characteristics	Symbol	Rating	Unit
DC forward current	I_{F}	70	mA
Pulse forward current*3	$I_{ m PF}$	150	mA
Reverse voltage	$ V_R$	10	V
Junction temperature	$T_{ m J}$	125	°C
Operating temperature range	T_{OP}	-40-105	°C
Storage temperature range	T_{STG}	-40-105	°C
Soldering temperature*4	T_{SD}	260	°C
Thermal Resistance Junction/ Solder Point	Rth	100	°C/W

Notes 1: There is no maximum or typical voltage parameter

- 2: For other ambient, limited setting of current will be depended on de-rating curves.
- 3: Duty 1/10, pulse width 0.1ms
- 4: The maximum of soldering time is 5 seconds in $T_{SD}\,$



■ Typical Product Characteristics (Ta=25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test condition
Forward Voltage	V_{F}	1.8	2.2	2.8	V	I _F =70mA
Reverse Current	I_R	-	-	10	μΑ	$V_R=10V$
Luminous Intensity	Iv	1300	2400	-	mcd	I _F =70mA
Dominant Wavelength	λd	620		630	nm	$I_F=70\text{mA}$
View Angle	$2\theta_{1/2}$	-	120	-	deg	I _F =70mA

Notes: 1. Measurement Errors: Forward Voltage: ±0.1V, Luminous Intensity: ±10% Iv, Dominant Wavelength: ±1.0nm

■ Range of Bins

1). Forward Voltage Bins $(I_F=70\text{mA})$

Bin code	Min. V _F (V)	Max. V _F (V)
В	1.8	1.9
С	1.9	2.0
D	2.0	2.1
Е	2.1	2.2
F	2.2	2.3
G	2.3	2.4
Н	2.4	2.5
I	2.5	2.6
J	2.6	2.7
K	2.7	2.8

2).Luminous Intensity Bins (I_F=70mA)

Din oodo	Min. I _V	Max. I _V
Bin code	(mcd)	(mcd)
16	1300	1700
17	1700	2200
18	2200	2800
19	2800	3600

3). Dominant Wavelength Bins (I_F=70mA)

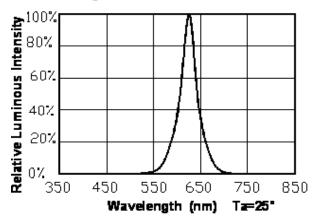
Bin code	Bin code Min. λd Max. λd (nm)		
С	620	625	
D	625	630	

^{2.} Electrical-Optical Characteristics (Ta=25°C)

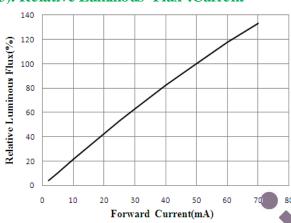


Electrical-Optical Characteristics

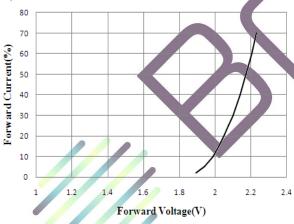
1). Relative Spectral Distribution



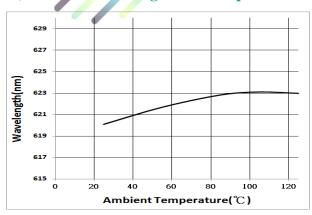
3). Relative Luminous Flux .Current



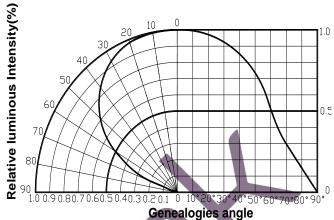
5). Electrical Characteristics



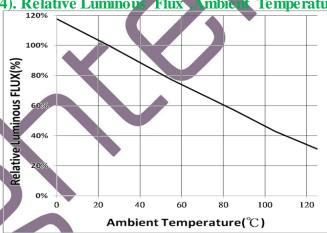
7). Relative Wavelength and Temperature



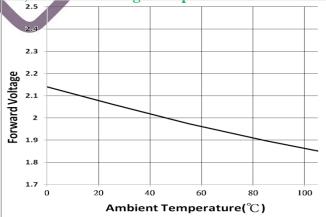
2). Typical Spatial Distribution



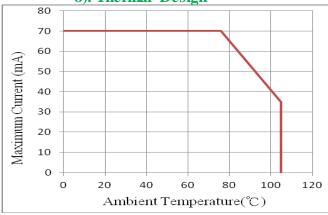
4). Relative Luminou **Temperature**



6).For ard Voltage Temperature

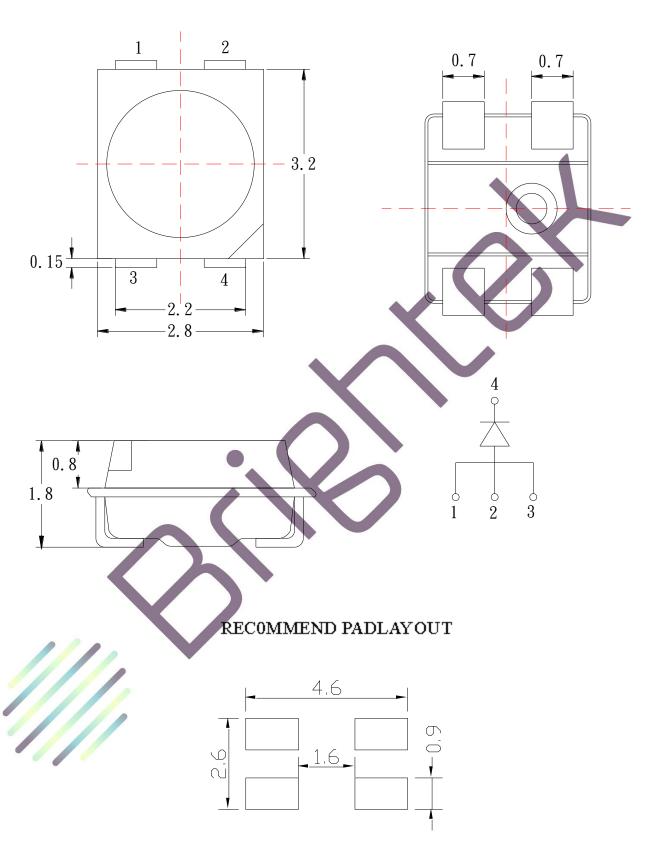


8). Thermal Design





Dimensions

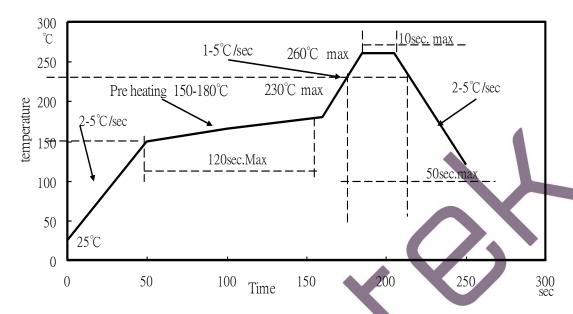


- Notes: 1. All dimensions are in millimeters (inches)
 - 2. Tolerance is ± 0.1 (± 0.004 ")mm unless otherwise noted
 - 3. Specifications are subject to change without notice.



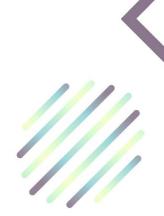
Reflow Profile

1. I_R reflow soldering Profile for Lead Free solder



Notes:

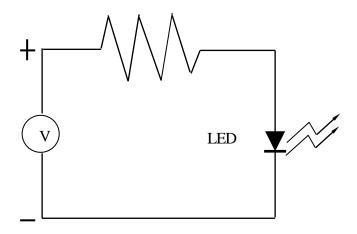
- 1. We recommend the reflow temperature $240^{\circ}\text{C}(\pm 5^{\circ}\text{C})$. the maximum soldering temperature should be limited to 260°C .
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be less than 3 times.





■ Test Circuit and Handling Precautions

1. Test circuit



2. Handling precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C} (41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <60% R.H. after the package is Opened, the products should be used within 4 weeks or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

If the package has been opened for more than 4 weeks, it is recommended to bake the products with the following instruction:

- 1). $60\pm3^{\circ}$ C X 6hrs and < 5%RH, for reel
- 2). $125\pm3^{\circ}$ C X 2hrs, for single LED

It shall be normal to see slight color fading of carrier (light yellow) after baking in process



Packing

• Feeding Direction

Feeding Direction

Dimensions of Reel (Unit: mm)

• Dimensions of Tape (Unit: mm)

1. 55±0. 05

2. 0±0. 05

4. 0±0. 10

Polority

Mark

A 0±0. 10

2. 0±0. 05

2. 0±0. 05

2. 0±0. 05

2. 0±0. 05

2. 0±0. 05

2. 0±0. 05

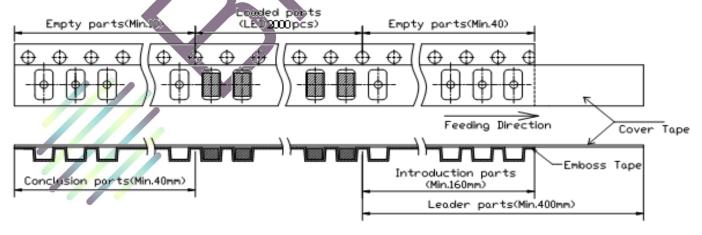
2. 0±0. 05

2. 0±0. 05

4. 0±0. 10

2. 0±0. 10

Arrangement of Tape



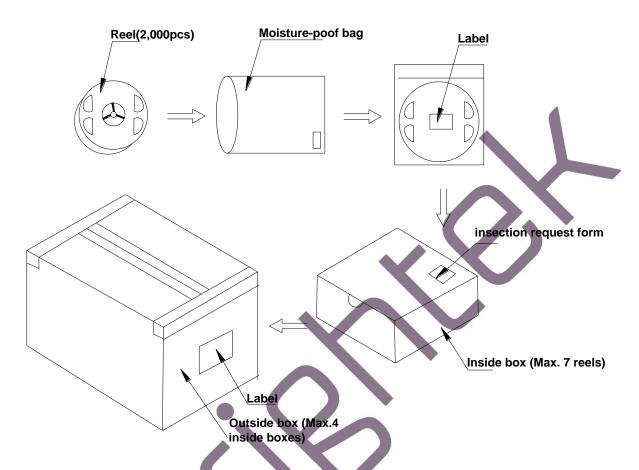
Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The max loss number of SMD is 2pcs;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
- 4. 2,000pcs per reel;
- 5. The remainder packing in multiples of 500pcs.



Packing

Packaging Specifications



Notes:

Reeled product (max.2,000) is packed in a sealed moisture-proof bag. Seven bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.

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Precautions

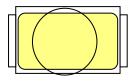
1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

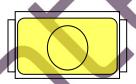
2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area



Picture $1(\sqrt{})$



Picture 2(X)

3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

4. This usage and handling instruction is only for your reference.





Test Items and Results of Reliability

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Test Item	Test Conditions	Duration/ Cycle	Ac/Re	Number of Damage	Reference
Normal Temperature Life	$Ta = 23^{\circ}C (\pm 5^{\circ}C)$ $I_F = 70 \text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
High Temperature Life	$Ta = 85^{\circ}C (\pm 5^{\circ}C)$ $I_F = 70 \text{mA}$	1008 hrs	0/1	0/22	JESD22 A-108
High Humidity Heat Life	Ta=85°C (±5°C) RH=85% I _F =70mA	1008 hrs	0/1	0/22	JESD22 A-108
Thermal shock	-45°C /30min~105°C /30min (±5°C)	1008 hrs	0/1	0/22	JESD22 A-104
Electrostatic Discharge (ESD) Test	According to the SPEC	3 cycles	0/1	0/22	AEC Q101-001
Low Temperature Storage	T _a =-40°C	1008 hrs	0/1	0/22	JESD22-A103D
High Temperature Storage	T _a =125℃	1008 hrs	0/1	0/22	JESD22-A103D

*Criteria for Judging						
Item	Cymbol	Condition	Criteria for Judgment of Pass			
Item	Symbol	Condition	Min	Max		
Forward Voltage	V_{F}	I _F =70mA	-	USL* ¹ ×1.1		
Reverse Current	I_R	V _R = 10V	-	10μΑ		
Luminous Intensity	Iv	I _F =70mA	LSL*2×0.7	-		

[Note] USL*1: Upper Specification Level

LSL*2: Lower Specification Level

单击下面可查看定价,库存,交付和生命周期等信息

>>Brightek(弘凱光電)